## **PATENT ASSIGNMENT COVER SHEET**

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
JOHNNY CHAN	07/15/2016
HSI-HSIEN HUNG	07/15/2016

#### **RECEIVING PARTY DATA**

Name:	WINBOND ELECTRONICS CORPORATION
Street Address:	NO. 8, KEYA 1ST RD.
Internal Address:	DAYA DIST., CENTRAL TAIWAN PARK
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State/Country:	TAIWAN
Postal Code:	428

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15213030

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	06484.0267-00000
NAME OF SUBMITTER:	AMY-MARIE GONNELLA
SIGNATURE:	/Amy-Marie Gonnella/
DATE SIGNED:	07/18/2016
	This document serves as an Oath/Declaration (37 CFR 1.63).

**Total Attachments: 2** 

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> PATENT REEL: 039181 FRAME: 0359

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# ASSIGNMENT AND DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

#### **ASSIGNMENT:**

WHEREAS I/We, the below-named inventor(s), (hereinafter referred to as Assignor(s)), of an invention entitled:

### MEMORY DEVICE AND STRESS TESTING METHOD OF SAME

filed herewith or onas United States Application No(Confirmation No) attached hereto and/or PCT International Application No; and
WHEREAS, Winbond Electronics Corporation
a corporation of Taiwan, Republic of China
whose post office address is No. 8, Keya 1st Rd., Daya Dist., Central Taiwan Park, Taichung City, 428 Taiwan, ROC
(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;
NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I/We, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention, provisional Application No
AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;
AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.
AND, I/WE HEREBY authorize and request that the attorneys having Power of Attorney in this application, insert here in parentheses (Application No, filed) the filing date and application number of said application when known.

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#### **DECLARATION:**

As a named inventor below, I hereby declare that: (1) This declaration is directed to the above-identified application; (2) the above-identified application was made or authorized to be made by me; (3) my residence and mailing address are as stated below next to my name; and (4) I believe I am an original inventor or an original joint inventor of a claimed invention in the application. I hereby acknowledge that any willful false statements made in this declaration are punishable by fine or imprisonment of not more than five (5) years, or both, under section 1001 of Title 18 of the United States Code.

As a below named inventor, I have reviewed and understand the contents of the application, including the claims, and am aware of the duty to disclose to the US PTO all information known to me to be material to patentability as defined in 37C.F.R. § 1.56.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

LEGAL NAME OF FIRST INVENTOR     Johnny CHAN	SIGNATURE SIGNATURE	7-15-2016
MAILING ADDRESS 39500 Platero Pl., Fremont, CA 94539	RESIDENCE Fremont, CA, US	
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2. LEGAL NAME OF SECOND INVENTOR HSI-HSIEN HUNG MAILING ADDRESS	SIGNATURE	DATE 2-15-Z016